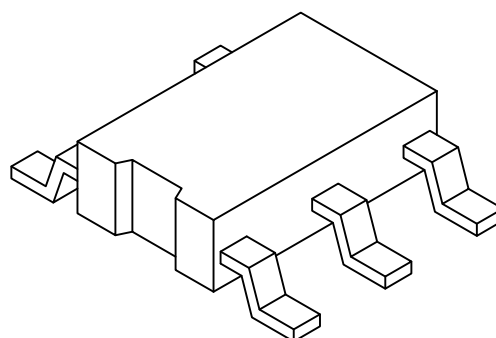
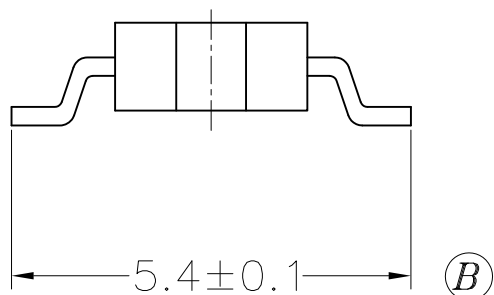
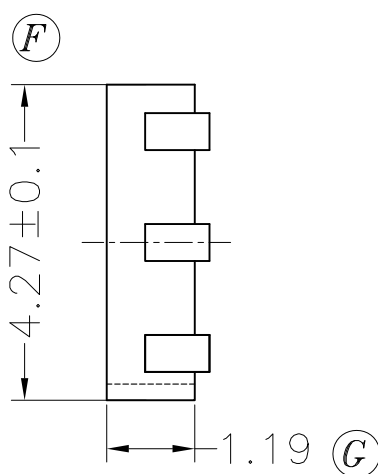
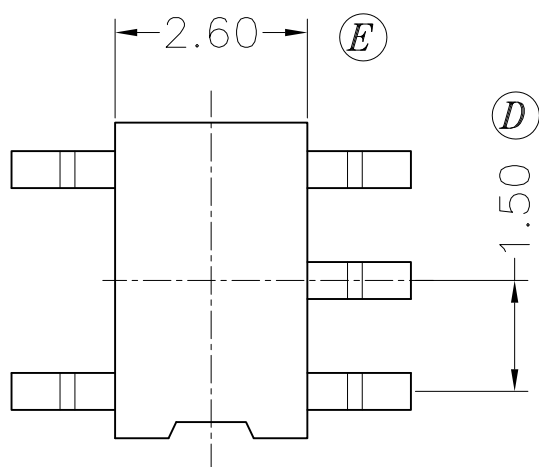
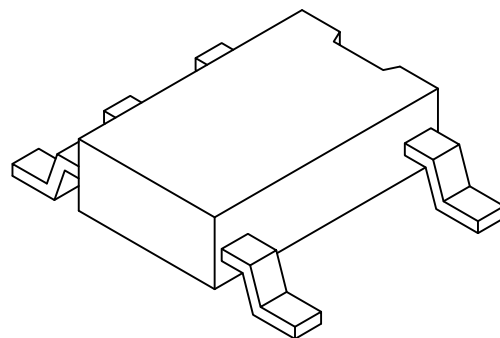
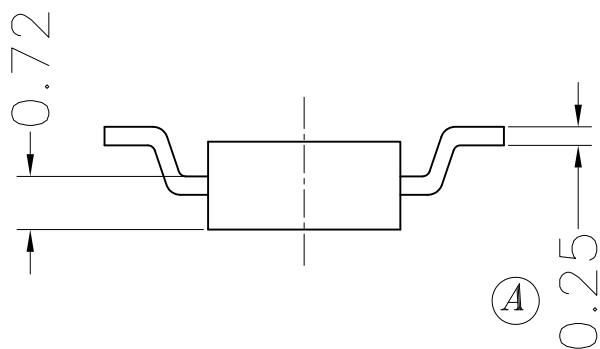




REV.	REVISIONS	REC.	DATE	REV.	REVISIONS	REC.	DATE
0	初版发行		SEP. 27'06	3	整理版发行		MAY.27 '09
1	端子厚度更改为0.25mm		Mar.. 08'07				
2	0.80mm尺寸更改为0.72mm		Mar.. 29'07				

DRAWN & DRAFTED BY	Ldping	TOLERANCES	ANGLE:	TITLE:
CHECKED & APPROVED BY	BEN LEE	0<L≤4 ±0.1 4<L≤16 ±0.2 16<L≤63 ±0.3	±1°	SMD BASE B4F
		pin pitch ±0.2	UNIT: MM	PLASTIC MATERIAL: DAP WH9100HM
			ORIGIN: GZ	METAL MATERIAL: PHOSPHOR BRONZE
				UL REC. UL 94V-0
				PIN TENSION LOAD: 1.0Kg
				DATE: MAY.27 '2009
				DRAWING NO. ST-BS032.01
				REV. 3



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